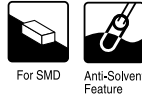
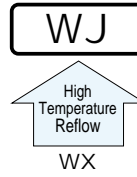


WJ

5.5mmL Chip Type
High Temperature (260°C) Reflow series



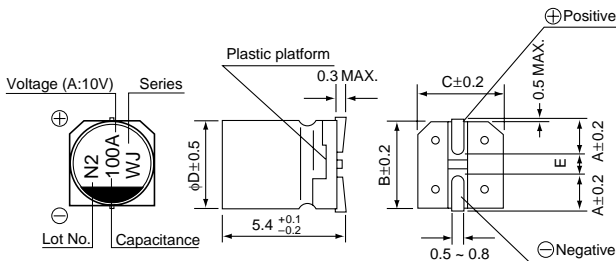
- Corresponding with 260°C peak reflow soldering
Recommended reflow condition : 260°C peak 5 sec. 230°C over 60 sec. 2 times
- Chip type with 5.5mm height.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine using carrier tape.
- Load life of 2000 hours at 85°C
- Adapted to the RoHS directive (2002/95/EC).



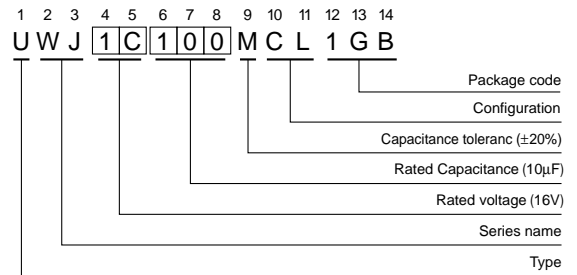
Specifications

Item	Performance Characteristics						
Category Temperature Range	-40 ~ +85°C						
Rated Voltage Range	6.3 ~ 50V						
Rated Capacitance Range	0.1 ~ 150μF						
Capacitance Tolerance	±20% at 120Hz, 20°C						
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01CV or 3 (μA) ,whichever is greater.						
tan δ	Measurement frequency : 120Hz, Temperature : 20°C						
	Rated voltage (V)	6.3	10	16	25	35	50
	tan δ (MAX.)	0.26	0.20	0.16	0.14	0.12	0.12
Stability at Low Temperature	Measurement frequency : 120Hz						
	Rated voltage (V)	6.3	10	16	25	35	50
	Impedance ratio ZT / Z20 (MAX.)	Z-25°C / Z+20°C	4	3	2	2	2
		Z-40°C / Z+20°C	8	8	4	4	3
Endurance	After 2000 hours' application of rated voltage at 85°C, capacitors meet the characteristic requirements listed at right.		Capacitance change	Within ±20% of initial value			
			tan δ	200% or less of initial specified value			
		Leakage Current	Initial specified value or less				
Shelf Life	After storing the capacitors under no load at 85°C for 1000 hours, and after performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they will meet the specified value for endurance characteristics listed above.						
Resistance to soldering heat	The capacitors shall be kept on the hot plate maintained at 250°C for 30 seconds. After removing from the hot plate and restored at room temperature, they meet the characteristic requirements listed at right.		Capacitance change	Within ±10% of initial value			
			tan δ	Initial specified value or less			
		Leakage current	Initial specified value or less				
Marking	Black print on the case top.						

Chip Type



Type numbering system (Example : 16V 10μF)



Voltage

V	6.3	10	16	25	35	50
Code	j	A	C	E	V	H

	(mm)		
φD	4	5	6.3
A	1.8	2.1	2.4
B	4.3	5.3	6.6
C	4.3	5.3	6.6
E	1.0	1.3	2.2

● Dimension table in next page.

■Dimensions

Cap. (μF)	Code	6.3		10		16		25		35		50	
		0J		1A		1C		1E		1V		1H	
0.1	0R1											4	1.0
0.22	R22											4	2.0
0.33	R33											4	2.8
0.47	R47											4	4.0
1	010											4	8.4
2.2	2R2											4	13
3.3	3R3											4	17
4.7	4R7							4	16	4	18	5	20
10	100					4	23	5	27	5	29	6.3	33
22	220	4	28	5	33	5	37	6.3	42	6.3	45		
33	330	5	37	5	41	6.3	49	6.3	52				
47	470	5	45	6.3	52	6.3	58						
100	101	6.3	70	6.3	76	6.3	86						
150	151	6.3	71									Case size φ D (mm)	Rated ripple

Rated Ripple (mArms) at 85°C 120Hz

●Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz~
Coefficient	0.70	1.00	1.17	1.36	1.50

- Taping specifications are given in page 24.
- Recommended land size, soldering by reflow are given in page 25, 26.
- Please refer to page 3 for the minimum order quantity.